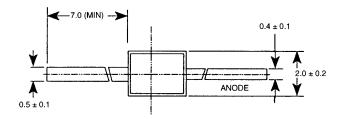
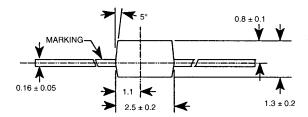


SURFACE MOUNT LED LAMP **FLAT TYPE**

RED	QTLP282-2	CLEAR
YELLOW	QTLP282-3	CLEAR
GREEN	QTLP282-4	CLEAR
AlGaAs/RED	QTLP282-7	CLEAR







DESCRIPTION

These subminiature LED lamps are intended for high volume, low cost status indication on PCBs, and for backlighting keyboards and switches. They are compatible with vapor phase reflow or wave solder surface mount equipment. Available in "Gull-Wing" lead bend configuration. They have clear, flat lenses. Tape and reel options are also available.

- Subminiature package
- Flat package profile

FEATURE

- Wide viewing angle
- Lead bend options for surface mounting

ST1709

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS
- 2. LEAD SPACING IS MEASURED WHERE THE LEADS EMERGE FROM THE PACKAGE 3. PROTRUDED RESIN UNDER THE FLANGE IS 1.5 mm (0.059") MAXIMUM

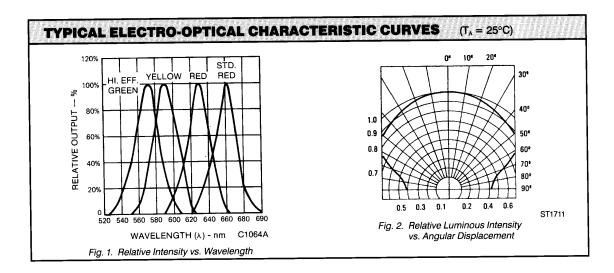
PART NUMBER QTLP-	282-2	282-3	282-4	282-7
DC forward current (I) Operating temperature range Storage temperature range Lead soldering time (at 1/16 inch (1.6 mm) from the bottom of lamp)	30 mA	20 mA 40°C to + 40°C to + 5 seconds @	-100°C	40 mA
Peak forward current	160 mA	160 mA	160 mA	200 mA
Power dissipation (P _d)	100 mW	85 mW 20 m	100 mW A	110 mA



SEMICONDUCTOR

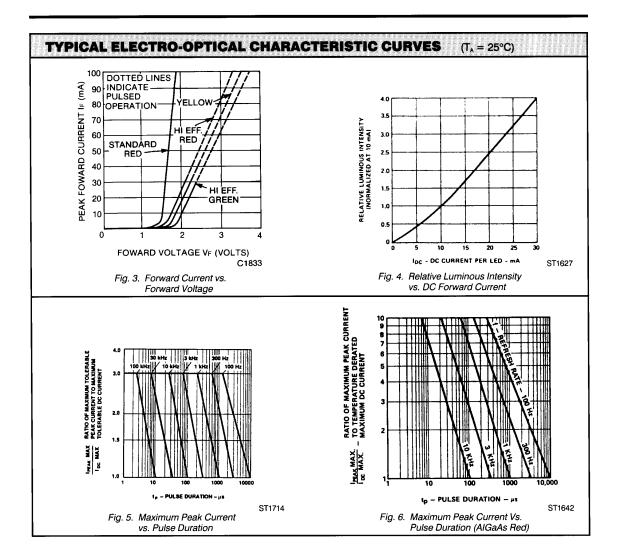
SURFACE MOUNT LED LAMP FLAT TYPE

ELECTRO-OPTICAL CHARACTERISTICS (T_=25°C Unless Otherwise Specified) TEST CONDITIONS 282-2 282-3 282-4 282-7 PART NUMBER l_F=20 mA Luminous intensity (mcd) 11 1.0 3.5 minimum 1.5 17 5.6 typical 5.6 6.0 $I_F = 20 \text{ mA}$ Forward voltage (V_F) 1.7 minimum 1.7 1.7 1.7 2.0 typical 2.1 2.0 2.0 2.8 2.8 2.8 2.8 maximum I_F=20 mA 660 565 Peak wavelength (nm) 640 585 I₌=20 mA 20 Spectral line half width (nm) 45 35 30 5 $I_{R} = 10 \ \mu A$ $I_{F} = 20 \ mA$ Reverse breakdown voltage (V_R) Viewing angle (°) 5 5 5 150 150 150 150





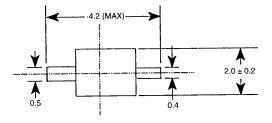
SURFACE MOUNT LED LAMP FLAT TYPE

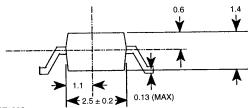




SEMICONDUCTOR

LEAD BEND OPTIONS





ST1690

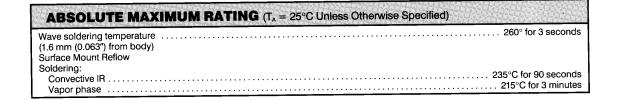
SURFACE MOUNT OPTION FOR QTLP282-X FLAT TYPE LED LAMP GULL WING LEAD CONFIGURATION

DESCRIPTION

These flat package LED lamps are encapsulated in an axial lead package with a clear lens. Automatic placement equipment can be used to mouont these LEDs on PC boards. The lamps can be mounted using either batch or in line vapor phase reflow solder processes. Subminature lamps are availabe in red, high efficiency red, yellow, and green.



- Gull Wing lead configuration for surface mount application
- Compatible with automatic placement equipment
- Compatible with vapor phase reflow solder processes.
- Supplied on tape and reel or in bulk packaging



ABSOLUTE MAXIMUM SOLDER RATINGS AND ELECTRICAL/OPTICAL CHARACTERISTICS

The absolute maximum ratings and electrical/optical specifications are identical to the basic catalogue device, except for the vapor phase soldering rating as specified above.



SURFACE MOUNT LED LAMP FLAT TYPE

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.